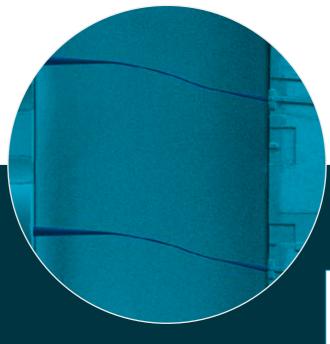


connect the world by lighting the way

THE ESSENTIAL LINK IN NEXT-GENERATION OPTICAL CONNECTIVITY





LEARN MORE

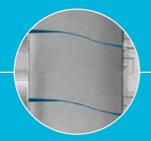
Photonic Integration

WITH PASSIVE ALIGNMENT AND 3D LITHOGRAPHY

- Scalable manufacturing solutions with fully automated machines
- Simplified photonic integration, no active alignment & no additional optics
- Compatible with silicon photonics and more, improving coupling efficiency and increasing yield. Passes reliability testing

" Powering the new era of photonic devices with passive photonic integration and fully automated processes "

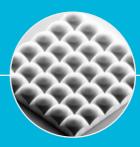
Our Product Areas



PHOTONIC WIRE BONDS



MICRO-LENSES



MICRO-LENS-ARRAYS

"Our optical interposer together with Vanguard Automation's facetattached micro-lenses create a powerful platform for electro-optical engines for transceivers, co-packaged optics, light engines and sensing devices"

AUTOMATED LITHOGRAPHY BASED 3D NANO-PRINTING

High-precision manufacturing of low-loss photonic interconnects



- Scalable production of Photonic Wire Bonds and facet-attached micro-optics
- Industry-grade opto-mechanical design, suitable for processing small batches up to 12" wafers
- Suitable for use with silicon photonics, silicon nitride, indium phosphide and other material platforms.
- Compatible with single mode fibers, multi-core fibers and fiber arrays



"Photonic Wire Bonding will be a fundamental packaging technology for next generation highly integrated photonic subassemblies offering not only compact form factors but also low optical loss "

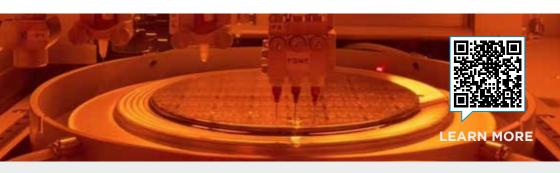
Gordon Morrison, VP of Luminar Semi

AUTOMATED PRE- AND POST-PROCESSING

Complete post-processing tool for development at high volume



- Providing reliable manufacturing with high yield and high reliability
- Designed for processing small batches up to 12" wafers
- High-speed, high-precision
 XYZ-gantry system. UV flood light
 unit and nitrogen inlets for curing
 and drying
- Suitable for use with fibers, siliconphotonics, silicon nitride, indium phosphide & other material platform



"This is a significant expansion of our capabilities, offering interesting technological avenues. We are already working in collaboration with customers and partners on Photonic Wire Bonding concepts with great commercialization potential."

Marie-Josée Turgeon, President & General Manager of MiQro Innovation Collaborative Centre (C2MI)

Complete Process Solution

SUITABLE FROM PROTOTYPING TO VOLUME PRODUCTION

vanguard SONATA1000 automatically fabricates photonic interconnects

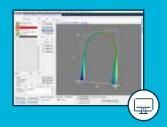
Assemblies and wafers are loaded into the vanguard SONATA1000 for photonic interconnect fabrication (Photonic Wire Bonds and facet-attached micro-lenses).





VanCore photoresist, our proprietary material series designed for high-yield 3D lithography and reliability compliance, is precisely dropplaced onto the assemblies.

In-house developed software **BrightWire3D** detects the waveguide positions and calculates the optimum trajectory for low-loss photonic interconnects.



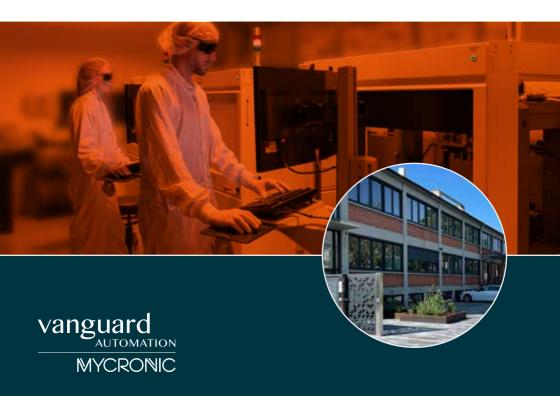


Post-processing and final curing are completed in the vanguard REPRISE1000

Fully Automated Manufacturing Solutions

DESIGN AND MANUFACTURE NEXT-GENERATION OPTICAL DEVICES

Headquartered in Karlsruhe, Germany, we empower industry and research to design and manufacture next-generation optical devices through automated interconnect solutions that overcome design, performance, and scalability challenges. Since April 2024, Vanguard Automation joined Mycronic, a Swedish high-tech group, listed on NASDAQ OMX Stockholm.



Vanguard Automation GmbH Gablonzer Strasse 10, 76185 Karlsruhe, Germany sales.vanguard@mycronic.com